

DATA SHEET

SKY13399-468LF: 10 to 2700 MHz DPx3T Switch

Applications

• GSM, DCS, PCS, CDMA, WCDMA, and TD-SCDMA differential filter switching

Features

- Broadband frequency range: 10 to 2700 MHz
- · Low insertion loss:
- 0.25 dB typical @ 25 MHz
- 0.35 dB typical @ 1 GHz
- 0.4 dB typical @ 2.2 GHz
- Wide VDD supply range: 2.5 to 4.8 V
- · Crossovers implemented on die for ease of use
- Small, QFN (18-pin, 2 x 2 mm) package (MSL1, 260 °C per JEDEC J-STD-020)



Skyworks GreenTM products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green*TM, document number SQ04-0074.







Figure 1. SKY13399-468LF Block Diagram

Description

The SKY13399-468LF is a double-pole, crossed three-throw (DPx3T) switch with on-die crossovers. The two inputs can be switched to three different pairs of outputs. Two control lines are used to determine which pair of outputs is connected.

The SKY13399-468LF is manufactured using a state of the art silicon on insulator (SOI) process, and is provided in a compact Quad Flat No-Lead (QFN) $2 \times 2 \text{ mm package}$.

A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

Table 1. SKY13399-468LF Signal Descriptions

| Pin | Name | Description | Pin | Name | Description |
|-----|-----------|---------------------------------|-----|-----------|---------------------------------|
| 1 | GND | Ground | 10 | GND | Ground |
| 2 | GND | Ground | 11 | INPUT_B | RF input |
| 3 | OUTPUT_2A | RF output paired with output 2B | 12 | INPUT_A | RF input |
| 4 | OUTPUT_2B | RF output paired with output 2A | 13 | VDD | Supply voltage input. |
| 5 | GND | Ground | 14 | GND | Ground |
| 6 | OUTPUT_1B | RF output paired with output 1A | 15 | VCTL2 | Switch control voltage 2 |
| 7 | OUTPUT_1A | RF output paired with output 1B | 16 | VCTL1 | Switch control voltage 1 |
| 8 | GND | Ground | 17 | OUTPUT_3B | RF output paired with output 3A |
| 9 | GND | Ground | 18 | OUTPUT_3A | RF output paired with output 3B |

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY13399-468LF are provided in Table 2. Electrical specifications are provided in Table 3.

Typical performance characteristics of the SKY13399-468LF are illustrated in Figures 3 through 8.

Operating logic is described in Table 4.

Table 2. SKY13399-468LF Absolute Maximum Ratings (Note 1)

| Parameter | Symbol | Minimum | Maximum | Units |
|-----------------------|--------|---------|---------|-------|
| Supply voltage | Vdd | | 5 | V |
| Control voltage | Vctl | | 3.0 | V |
| Input power | Pin | | +30 | dBm |
| Storage temperature | Тята | -40 | +125 | °C |
| Operating temperature | Тор | -40 | +85 | °C |

Note 1: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

CAUTION: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

Table 3. SKY13399-468LF Electrical Specifications (1 of 2) (Note 1) (Vod = 2.7 V, VctL = 1.8 V, PIN = 0 dBm, Top = +25 °C, Characteristic Impedance [Zo] = 50 Ω , Unless Otherwise Noted)

| Parameter | Symbol | Test Condition | Min | Typical | Max | Units |
|--|---------|---|----------------|----------------------|----------------------|----------------|
| Insertion loss (INPUT_A/B to OUTPUT_1A/B, OUTPUT_2A/B, and OUTPUT_3A/B) | | 25 MHz 0.7 to 1.0 GHz 1.8 to 2.2 GHz | | 0.25 0.35 0.40 | 0.35 0.45 0.55 | dB dB dB |
| Isolation (INPUT_A/B to OUTPUT_1A/B, OUTPUT_2A/B, and OUTPUT_3A/B) | | 25 MHz 0.7 to 1.0 GHz 1.8 to 2.2 GHz | 55 33 24 | 64 42 33 | | dB dB dB |
| Isolation (INPUT_A to INPUT_B) | ANTiso | 25 MHz 0.7 to 1.0 GHz 1.8 to 2.2 GHz | 50 25 19 | 60 27 21 | | dB dB dB |
| Return loss (INPUT_A/B to OUTPUT_1A/B, OUTPUT_2A/B, and OUTPUT_3A/B) | | 25 MHz 0.7 to 2.2 GHz | 17 15 | 25 20 | | dB dB |
| Phase error (A vs B path) | | | -3 | | +3 | deg |
| Switching on/off time | | 50% Vcт∟ to 90/10% RF | | 550 | | ns |
| 0.1 dB input compression point | IP0.1dB | 25 MHz 0.7 to 2.2 GHz | | +29 +30 | | dBm dBm |
| Harmonics | | $P_{IN} = +10 \text{ dBm},$ 0.7 to 2.2 GHz | | +100 | | dBc |
| Triple beat ratio | | Transmit power = -24 dBm, blocking power = -20 dBm, transmit frequency = 826 and 827 MHz, blocking frequency = 871 MHz, measured at 870 and 872 MHz | | +110 | | dBc |
| Second order intermodulation distortion | IMD2 | Transmit power = -30 dBm, blocking power = -15 dBm Band 5: transmit frequency = 836.5 MHz, blocking frequency = 45.1718 MHz, receive frequency = 881.5 MHz Band 8: transmit frequency = 897.5 MHz, blocking frequency = 45 and 1840 MHz, receive frequency = 942.5 MHz Band 17: transmit frequency = 710 MHz, blocking frequency = 30 and 1450 MHz, receive frequency = 740 MHz | | +130 | | dBc |
| Third order intermodulation distortion | IMD3 | Transmit power = -24 dBm, blocking power = -20 dBm Band 5: transmit frequency = 836.5 MHz, blocking frequency = 791.5 and 2554.5 MHz, receive frequency = 881.5 MHz Band 8: transmit frequency = 897.5 MHz, blocking frequency = 852.5 and 2737.5 MHz, receive frequency = 942.5 MHz Band 17: transmit frequency = 710 MHz, blocking frequency = 680 and 2160 MHz, receive frequency = 740 MHz | | _120 | | dBo |

| | | | | | - | |
|--------------------|-----------|----------------------------|------|---------|------|-------|
| Parameter | Symbol | Test Condition | Min | Typical | Max | Units |
| Spurious emissions | | Any frequency, no RF input | | | -110 | dBm |
| Control voltage | Vctl_low | | 0 | | 0.50 | V |
| | Vctl_high | | 1.65 | | 2.70 | V |
| Supply voltage | Vdd | | 2.5 | | 5.0 | V |
| Supply current | ldd | VDD = 2.7 V | | 33.5 | | μA |
| Control current | ICTL | | | | 2 | μA |

Table 3. SKY13399-468LF Electrical Specifications (2 of 2) (Note 1)

(VDD = 2.7 V, VCTL = 1.8 V, PIN = 0 dBm, Top = +25 °C, Characteristic Impedance [Zo] = 50 Ω , Unless Otherwise Noted)

 $\label{eq:Note 1: Performance is guaranteed only under the conditions listed in this table.$

Table 4. SKY13399-468LF Truth Table (Note 1)

| VCTL1 (Pin 16) | VCTL2 (Pin 15) | Insertion Loss Path |
|-------------------|-------------------|---|
| 1 | 0 | INPUT_A to OUTPUT_1A, INPUT_B to OUTPUT_1B |
| 0 | 0 | INPUT_A to OUTPUT_2A, INPUT_B to OUTPUT_2B |
| 0 | 1 | INPUT_A to OUTPUT_3A, INPUT_B to OUTPUT_3B |

Note 1: "1" = +1.65 to +2.70 V. "0" = 0 V to +0.5 V. Any state other than described in this table places the switch into an undefined state. An undefined state will not damage the device.

Typical Performance Characteristics

(VDD = 2.7 V, VCTL = 1.8 V, PIN = 0 dBm, ToP = +25 °C, Characteristic Impedance [Zo] = 50 Ω, Unless Otherwise Noted)







Figure 4. Insertion Loss vs Frequency (2A, 2B)

















Evaluation Board

The SKY13399-468LF Evaluation Board is used to test the performance of the SKY13399-468LF DPx3T Switch. An Evaluation Board schematic diagram is provided in Figure 9. An assembly drawing for the Evaluation Board is shown in Figure 10.

Package Dimensions

The PCB layout footprint for the SKY13399-468LF is provided in Figure 11. Typical part markings are shown in Figure 12. Package dimensions are shown in Figure 13, and tape and reel dimensions are provided in Figure 14.

Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY13399-468LF is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.



Figure 9. SKY13399-468LF Evaluation Board Schematic



Figure 10. SKY13399-468LF Evaluation Board Assembly Diagram





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Figure 11. SKY13399-468LF PCB Layout Footprint





1. All measurements are in millimeters.

Dimensions and tolerances according to ASME Y14.5M-1994.
 Coplanarity applies to the terminals and all other bottom surface metallization.
 Dimension applies to metallized terminal. If the terminal has a radius on its end,

the width dimension should not be measured in that radius area.

Figure 13. SKY13399-468LF Package Dimensions

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Notes:

- Carrier tape must meet all requirements of Skyworks GP01-D232 procurement spec for tape and reel shipping.
 Carrier tape shall be black conductive polycarbonate bakeable material at 125 °C temperature.
- 3. Cover tape shall be transparent conductive with 5.40 mm width.
- 4. ESD-surface resistivity must meet all ESD requirements of Skyworks specified on GP01-D232.
- 5. All measurements are in millimeters.

Figure 14. SKY13399-468LF Tape and Reel Dimensions

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